ABP2 SERIES

Board Mount Pressure Sensors

High Accuracy, Compensated/Amplified 2.5 mbar to 12 bar | 250 Pa to 1.2 MPa | 1 inH₂O to 175 psi Digital or Analog Output, Liquid Media Capable

DESCRIPTION

The ABP2 Series are piezoresistive silicon pressure sensors offering a digital or analog output for reading pressure over the specified full scale pressure span and temperature range. They are calibrated and temperature compensated for sensor offset, sensitivity, temperature effects, and accuracy errors (which include non-linearity, repeatability and hysteresis) using an on-board Application Specific Integrated Circuit (ASIC). Calibrated output values for pressure and temperature are updated at approximately 200 Hz. All products are designed and manufactured according to ISO 9001 standards. The liquid media option includes an additional gel coating to protect the electronics under port P1, which enables use with non-corrosive liquids (e.g. water and saline) and in applications where condensation can occur. The ABP2 Series is available in tube packaging. Pocket tape and reel packaging is available upon request.

APPLICATIONS

- **Medical** Ventilators/portable ventilators, CPAP, blood analysis, blood pressure monitoring, breast pumps, drug dosing, hospital beds, massage machines, oxygen concentrators, patient monitoring, sleep apnea equipment, urine analyzers, and wound therapy
- Industrial HVAC transmitters, life sciences, material handling, pneumatic control and regulation, process gas monitoring, and valve positioning/positioners

- **Commercial** Air beds, coffee makers, washing machines, level measurement, dish washers, vacuum cleaners, hand dryers, and rice cookers
- Transportation Air brakes, CNG monitoring, fork lifts, and fuel level measurement

FEATURES

- Total Error Band (see Figure 1):
 - As low as ± 1.5 % FSS
- Liquid media option:
 - Compatible with a variety of liquid media
- Long-term stability:
 - As low as ± 0.2 % FSS
- Accuracy:
 - As low as ±0.25 % FSS BFSL
- Wide pressure range:
 - 2.5 mbar to 12 bar
 - 250 Pa to 1.2 MPa
 - $1 \text{ inH}_2\text{O to } 175 \text{ psi}$
- High burst pressures
- Wide operating temperature range of -40°C to 110°C [-40°F to 230°F]
- Calibrated over wide temperature range of -40°C to 110°C [-40°F to 230°F]
- 24-bit digital I²C or SPI-compatible output
- · Ratiometric analog output
- IoT (Internet of Things) ready interface
- Ultra-low power consumption:
 - As low as 0.01 mW typ. average power
 - 1 Hz measurement frequency
- Meets IPC/JEDEC J-STD-020E Moisture Sensitivity Level 2
- REACH and RoHS compliant
- Temperature output available
- NSF-169, LFGB and BPA compliant materials









PORTFOLIO

Honeywell offers a variety of board mount pressure sensors for use in medical and industrial applications. To view the entire product portfolio, click here.



VALUE TO CUSTOMERS

• Simplifies design-in

- Small size saves room on the PC board (PCB), simplifying design in smaller and lower power devices

• Meets IPC/JEDEC J-STD-020E **Moisture Sensitivity Level 2** requirements

- Allows avoidance of thermal and mechanical damage during solder reflow attachment and/or repair that lesser rated sensors may incur
- Allows for unlimited shelf life when stored inside sealed moisture barrier bag
- Allows for lean manufacturing due to stability and usability shortly after reflow

Cost-effective

- Small size helps engineers reduce design and manufacturing costs while maintaining enhanced performance and reliability of the systems they design

Accurate

- Total Error Band (TEB) and wide pressure range enable engineers to optimize system performance by improving resolution and system accuracy

Flexible

- Supply voltage range, variety of pressure units, types and ranges, output options, and wide operating temperature range simplify use in the application

Versatile

- Wet-media compatibility, low power, and temperature output options make the sensor a versatile choice for Internet of Things applications

DIFFERENTIATION

Application

- Specific design ensures suitability for a wide array of customer requirements

Digital output

- Allows the sensor to be directly plugged into the customer's circuitry without requiring major design changes

• Total Error Band (see Figure 1):

- Provides a more comprehensive measurement of performance over the compensated temperature range, which minimizes testing and calibrating every sensor, thereby potentially reducing manufacturing cost; improves sensor accuracy and offers ease of sensor interchangeability due to minimal part-to-part variation
- Improves sensor accuracy
- Offers ease of sensor interchangeability due to minimal part-to-part variation

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TOTAL ERROR BAND

Total Error Band (TEB) is a single specification that includes the major sources of sensor error. TEB should not be confused with accuracy, which is actually a component of TEB. TEB is the worst error that the sensor could experience.

Honeywell uses the TEB specification in its datasheet because it is the most comprehensive measurement of a sensor's true accuracy. Honeywell also provides the accuracy specification in order to provide a common comparison with competitors' literature that does not use the TEB specification.

Many competitors do not use TEB—they simply specify the accuracy of their device. Their accuracy specification, however, may exclude certain parameters. On their datasheet, the errors are listed individually. When combined, the total error (or what would be TEB) could be significant.

Figure 1. Total Error Band

Sources of Error

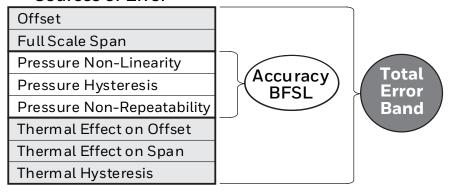


TABLE 1. ABSOLUTE MAXIMUM SPECIFICATIONS ¹					
Characteristic	Minimum	Maximum	Unit		
Supply voltage (V _{supply}): digital output analog output	-0.3 -0.3	3.6 6.0	Vdc		
Voltage on any pin	-0.3	V _{supply} + 0.3	Vdc		
Digital clock frequency: I ² C SPI	100 50	400 800	kHz		
ESD susceptibility (human body model)	2	_	kV		
Storage temperature range	-40 [-40]	125 [257]	°C [°F]		
Soldering time and temperature: lead (DIP) peak reflow (SMT, Leadless SMT)	4 s max. at 250°C [482°F] 15 s max. at 250°C [482°F]				

¹Absolute maximum ratings are the extreme limits the device will withstand without damage.

TABLE 2. OPERATING SPECIFICATIONS							
Characteristic	Analog			Digital			Unit
Characteristic	Minimum	Typical	Maximum	Minimum	Typical	Maximum	Onit
Supply voltage (V _{supply}) ¹ 3.3 Vdc 5.0 Vdc	3.0 4.75	3.3 5.0	3.6 5.25	1.8	3.3	3.6	Vdc
Current consumption: I ² C sleep/standby mode SPI sleep/standby mode	_ _	_ _	_ _	3.0 13.0	33.8 43.8	211.0 221.0	nA
Power consumption	_	9.5	_	_	3.1	_	mW
Operating temperature range ²	-40 [-40]	_	110 [230]	-40 [-40]	_	110 [230]	°C[°F]
Compensated temperature range ³	-40 [-40]	_	110 [230]	-40 [-40]	_	110 [230]	°C [°F]
Startup time ⁴	_	_	5	_	_	2.5	ms
Clipping limit for analog version: Upper Lower	_ 2.5	_ _	97.5 —	_ _	_ _	_ _	V_{supply}
Update/data rate	_	1000	_	161	204	_	Samples/s
SPI/I ² C voltage level: Low High	_ _	_ _	_ _	- 80	_ _	20 –	0∕0V _{supply}
Pull up on SDA, SCL	_	_	_	1	_	_	kOhm
Accuracy ⁵ 0 to 16 mBar 16 mBar to 12 Bar	_	_	±0.4 ±0.25	-	_	±0.4 ±0.25	% FSS BFSL ⁶
Resolution	0.03	_	_ _	_ 14	_	_ _	% FSS bits
Temperature output error ⁷	_	_	_	_	±5	_	°C

¹Sensors are not reverse polarity protected. Incorrect application of supply voltage or ground to the wrong pin may cause electrical failure.

² Operating temperature range: The temperature range over which the sensor will produce an output proportional to pressure.

³ Compensated temperature range: The temperature range over which the sensor will produce an output proportional to pressure within the specified performance limits (see Total Error Band).

⁴ Startup Time: For analog versions: 5 ms to data ready. For digital versions: 2.5 ms for power up to receive the first measurement command. Refer to Section 3.0, Tables 21, 22 and 25 for further details on communication timing.

⁵ Accuracy: The maximum deviation in output from a Best Fit Straight Line (BFSL) fitted to the output measured over the pressure range at 25°C [77°F]. Includes all errors due to pressure non-linearity, pressure hysteresis and non-repeatability.

⁶ Full Scale Span (FSS): The algebraic difference between the output signal measured at the maximum (Pmax.) and minimum (Pmin.) limits of the pressure range (see Figure 2).

⁷Temperature Output Error: The error in Temperature Output reading relative to a thermal reference standard over a temperature range of -40°C to 125°C.

TABLE 3. ENVIRONMENTAL SPECIFICATIONS					
Characteristic	Parameter				
Humidity: all external surfaces internal surfaces of liquid media options "T", "V", "G" and "F" internal surfaces of dry gases options "N" and "D"	0 %RH to 95 %RH, non-condensing 0 %RH to 100 %RH, condensing 0 %RH to 95 %RH, non-condensing				
Vibration	15 g, NSF169, BPA Free, LFGB 10 Hz to 2 kHz				
Shock	75 g, 6 ms duration				
Life ¹	1 million full scale pressure cycles minimum				
Solder reflow	J-STD-020-E, MSL2 (see shelf life/floor life)				
Shelflife	Unlimited storage life, inside sealed moisture barrier bag				
Floor life ³	1 year floor life, after removal from sealed moisture bag, $<\!30^{\circ}\!\text{C}\ \&\ <\!60\ \%\text{RH}$				
Certification (silicone gel coating option, Port 1 only) ²	NSF169, BPA Free, LFGB				

 $^{^1\}mathrm{Life}$ may vary depending on specific application in which the sensor is utilized.

³ Floor life, the maximum recommended time period after removal from a moisture barrier bag or dry storage prior to solder reflow. If the maximum recommended floor time is exceeded, parts may require to be baked at 85°C for up to 12 hours prior to solder reflow.

TABLE 4. WETTED MATERIALS ¹							
Commonant	Pressure Port 1 (P1)	D					
Component	Dry Gas Option	Liquid Media Option	Pressure Port 2 (P2)				
Ports and covers	High temperature polyamide, 304	High temperature polyamide					
Substrate	FR4	_	FR4				
Adhesives	Epoxy, silicone	Epoxy, silicone gel, fluorosilicone gel	Epoxy, silicone				
Electronic components	Silicon, glass, gold, aluminum	_	Silicon				

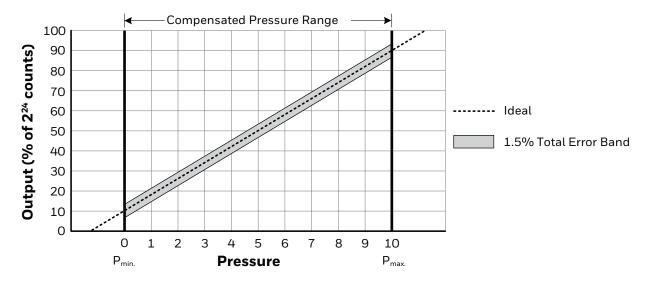
 $^{^{1}}$ Contact Honeywell customer service for detailed material information.

TABLE 5. SENSOR PRESSURE TYPES					
Pressure Type	Description				
Absolute	Output is proportional to the difference between pressure applied and a built-in vacuum reference.				
Differential	Output is proportional to the difference between the applied pressure to each port (Port1 - Port2)				
Gage	Output is proportional to the difference between applied pressure and atmospheric (ambient) pressure.				

TABLE 6. SENSOR OUTPUT AT SIGNIFICANT PERCENTAGES						
	Digital Versions		Analog Versions			
Output (%)	Counts		V _{SUPPLY}			
	Decimal	Hex	3.3 V	5.0 V		
0	0	0X000000	0.0	0.0		
10	1677722	OX19999A	0.33	0.5		
30	5033165	0X4CCCCC	0.99	1.5		
50	8388608	0X800000	1.65	2.5		
70	11744051	OXB33333	2.31	3.5		
90	15099494	0XE66666	2.97	4.5		
100	16777215	OXFFFFF	3.3	5.0		

²Sensor materials have been tested and certified for the food safety standards noted.

Figure 2. Transfer Function for Digital Output Versions



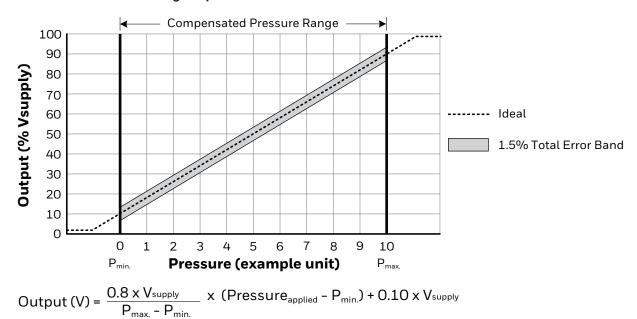
Pressure example 1: Transfer Function A (10% to 90%)

Output (% of
$$2^{24}$$
 counts) = $\frac{80\%}{P_{\text{max.}} - P_{\text{min.}}} \times (Pressure_{\text{applied}} - P_{\text{min.}}) + 10\%$

Pressure example 2: Transfer Function B (30% to 70%)

Output (% of
$$2^{24}$$
 counts) = $\frac{40\%}{P_{\text{max.}} - P_{\text{min.}}} \times (Pressure_{\text{applied}} - P_{\text{min.}}) + 30\%$

Figure 3. Transfer Function for Analog Output Versions



POWER CONSUMPTION AND STANDBY MODE

DIGITAL OUPTUT VERSIONS

The sensor is normally in Standby Mode and is only turned on in response to a user command, thus minimizing power consumption. Upon receiving the user command, the sensor wakes up from Standby Mode, runs a measurement in Active State, and automatically returns to Standby Mode, awaiting the next command. The resulting sensor power consumption is a function of the sampling rate (samples per second) as shown in Tables 7 and 8 and Figures 4 and 5.

TABLE 7. DIGITAL OUTPUT VERSIONS AVERAGE POWER CONSUMPTION AT 1.8 V _{SUPPLY} (ASSUMES COMMAND AA _{HEX})								
Sampling Rate (samples per second)	Average Power (mW)	Active Time (ms)	Active Power (mW)	Idle Time (ms)	Idle Power (mW)			
Minimum Average Power								
1	0.0068	3.625	1.884	996.375	0.000054			
2	0.0137	7.25	1.884	992.75	0.000054			
5	0.0341	18.125	1.884	981.875	0.000054			
10	0.0683	36.25	1.884	963.75	0.0000054			
20	0.1366	72.5	1.884	927.5	0.000054			
50	0.3414	181.25	1.884	818.75	0.000054			
100	0.6829	362.5	1.884	637.5	0.000054			
160	1.0926	580	1.884	420	0.000054			
Typical Average Powe	r							
1	0.0094	4.157	2.248	995.843	0.00006084			
2	0.0187	8.314	2.248	991.686	0.00006084			
5	0.0468	20.785	2.248	979.215	0.00006084			
10	0.0935	41.57	2.248	958.43	0.00006084			
20	0.1870	83.14	2.248	916.86	0.00006084			
50	0.4673	207.85	2.248	792.15	0.00006084			
100	0.9345	415.7	2.248	584.3	0.00006084			
160	1.4592	665.12	2.248	334.88	0.00006084			
Maximum Average Po	wer							
1	0.0129	4.839	2.588	995.161	0.0003798			
2	0.0254	9.678	2.588	990.322	0.0003798			
5	0.0630	24.195	2.588	975.805	0.0003798			
10	0.1256	48.39	2.588	951.61	0.0003798			
20	0.2508	96.78	2.588	903.22	0.0003798			
50	0.6264	241.95	2.588	758.05	0.0003798			
100	1.2524	483.9	2.588	516.1	0.0003798			
160	2.0036	774.24	2.588	225.76	0.0003798			

Figure 4. Digital Output Versions Average Power Consumption vs Sampling Rate at 1.8 V_{SUPPLY}

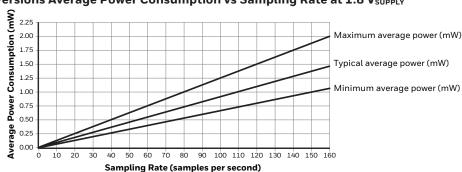
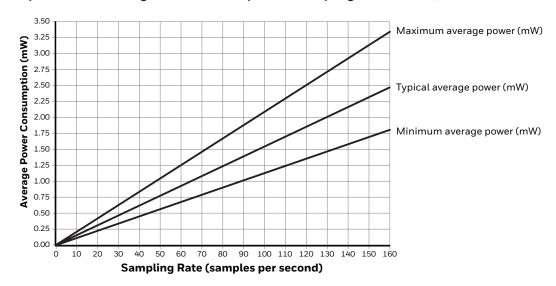


TABLE 8. DIGITAL OU	IPUI VERSIONS AV	ERAGE POWER CO	JNSUMPTION AT 3.	3 V _{SUPPLY} (ASSUMI	ES COMMAND AA _{HE)}			
Sampling Rate (samples per second)	Average Power (mW)	Active Time (ms)	Active Power (mW)	Idle Time (ms)	Idle Power (mW)			
Minimum Average Power								
1	0.0114	3.625	3.134	996.375	0.0000099			
2	0.0227	7.25	3.134	992.75	0.0000099			
5	0.0568	18.125	3.134	981.875	0.0000099			
10	0.1136	36.25	3.134	963.75	0.0000099			
20	0.2272	72.5	3.134	927.5	0.0000099			
50	0.5680	181.25	3.134	818.75	0.0000099			
100	1.1361	362.5	3.134	637.5	0.0000099			
160	1.8177	580	3.134	420	0.0000099			
Typical Average Powe	r							
1	0.0156	4.157	3.729	995.843	0.00011154			
2	0.0311	8.314	3.729	991.686	0.00011154			
5	0.0776	20.785	3.729	979.215	0.00011154			
10	0.1551	41.57	3.729	958.43	0.00011154			
20	0.3101	83.14	3.729	916.86	0.00011154			
50	0.7751	207.85	3.729	792.15	0.00011154			
100	1.5501	415.7	3.729	584.3	0.00011154			
160	2.4800	665.12	3.729	334.88	0.00011154			
Maximum Average Po	wer							
1	0.0214	4.839	4.275	995.161	0.0006963			
2	0.0421	9.678	4.275	990.322	0.0006963			
5	0.1041	24.195	4.275	975.805	0.0006963			
10	0.2075	48.39	4.275	951.61	0.0006963			
20	0.4144	96.78	4.275	903.22	0.0006963			
50	1.0349	241.95	4.275	758.05	0.0006963			
100	2.0692	483.9	4.275	516.1	0.0006963			
160	3.3103	774.24	4.275	225.76	0.0006963			

Figure 5. Digital Output Versions Average Power Consumption vs Sampling Rate at 3.3 VSUPPLY



ANALOG OUTPUT VERSIONS (SEE TABLE 9 AND FIGURE 6.)

TABLE 9. ANALOG OUTPUT VERSIONS POWER CONSUMPTION							
Vsupply (V)	Active Power (mW)	Minimum Power (mW)	Average Power (mW)	Maximum Power (mW)			
2.8	3.36	3.3	3.4	3.5			
3.3	4.62	4.4	4.5	4.7			
5	9.5	9.1	9.2	9.4			
5.5	11	10.9	11.0	11.1			

Figure 6. Analog Output Versions Average Power Consumption

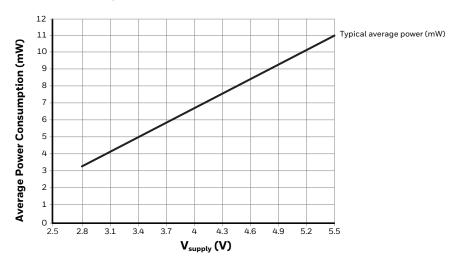
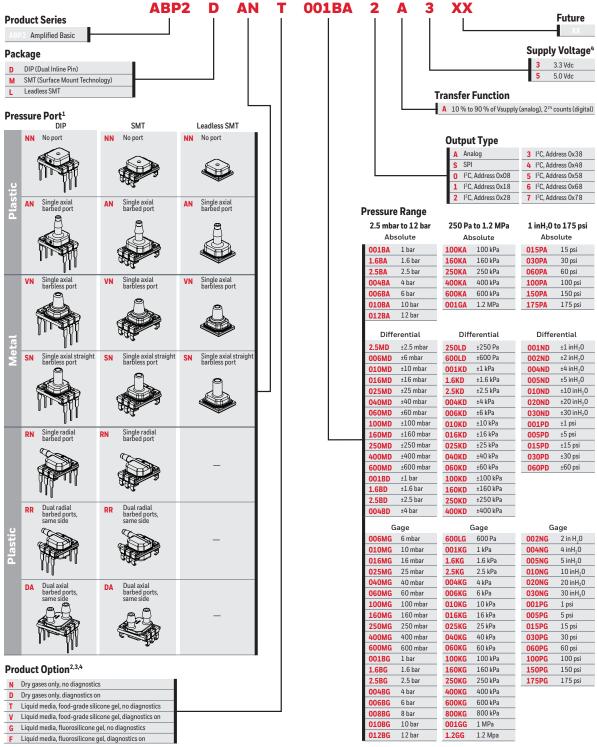


Figure 7. Nomenclature and Order Guide

For example, ABP2DANT001BA2A3XX defines an ABP2 Series Amplified Basic Pressure Sensor, DIP package, plastic single axial barbed pressure port, liquid media, food-grade silicone gel, no diagnostics, 1 bar absolute pressure range, digital I²C, address 0×28 output type, 10 % to 90 % of 224 counts (digital) transfer function, 3.3 Vdc supply voltage.



¹The "DA" Pressure Port is only available with Product Options "N" and "D". The "DA" Pressure Port is available in standard listings with pressure ranges up to 400 mbar | ±160 mbar. For higher pressure ranges, please contact the technical support team.

² Product Options "N" and "D" are only available with gage pressure ranges 6 mbar to 40 mbar | 600 Pa to 4 kPa | 2 in-H20 to 20 in-H20 and differential pressure ranges ±2.5 mbar to ±25 mbar |

^{±250} Pa to ± 2.5 kPa | ±1 in-H₂0 to ±10 in-H₂0.

³ Product Options "T" and "V" are only available with pressure ranges 60 mbar | 6 kPa | 1 psi gage and ±40 mbar | ±4 kPa | 1 psi differential and above

^{4 5} Vdc supply voltage and diagnostic options are only available with analog output listings. They are not available with digital output listings.

⁵ Ultra low pressure ranges less than 1 psi or 60 mbar are not available as standard listing in leadless package, please contact the technical support team for such requests.

⁶ ABP2 series pressure sensors are piezo-resistive based which are sensitive to change in light intensity. These semiconductor materials when exposed to light, change the output resulting in sensor offset voltage. For applications where direct exposure to light is possible, we recommend Flurosilicone gel listings which are less susceptible to light transmitting to the sense die.

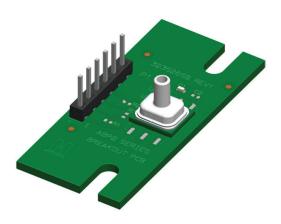
SELECT ABP2 SERIES SENSORS MOUNTED ON BREAKOUT BOARDS

Breakout boards, with or without the sensor premounted (see Figure 8 and Tables 10, 11, and 12) are designed for use with the Honeywell SEB Sensor Evaluation Kit.

Figure 8. APB2 Series Sensors and Breakout Boards

SN Leadless SMT sensor premounted on breakout board (ABP2LSNT060PGSA3BB)

Breakout board (ABP2-BREAKOUT-BRD)



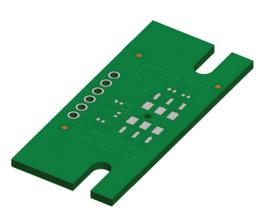


TABLE 10. ORDER GUIDE FOR ABP2 SERIES SENSORS AND BREAKOUT BOARDS					
Catalog Listing	Description				
ABP2MRRN004ND2A3BB	ABP2 Series sensor with SMT package, plastic dual radial barbed ports, same side pressure port, dry gases only, no diagnostics, ± 4 inH $_2$ O differential pressure range, I 2 C address 0x28, 10 % to 90 % of 2 24 counts digital transfer function, 3.3 Vdc supply premounted on breakout board				
ABP2MDAN004ND2A3BB	ABP2 Series sensor with SMT package, plastic dual axial barbed ports same side, dry gases only, no diagnostics, ± 4 inH $_2$ O differential pressure range, I 2 C address 0x28, 10 % to 90 % of 2 24 counts digital transfer function, 3.3 Vdc supply premounted on breakout board				
ABP2MVNT400MG2A3BB	ABP2 Series sensor with leaded SMT package, metal single axial tapered pressure port, liquid media, food-grade silicone gel, no diagnostics, 400 mbar gage pressure range, $\rm l^2C$ address 0x28, 10 % to 90 % of 2 24 counts digital transfer function, 3.3 Vdc supply premounted on breakout board				
ABP2LANT001PG2A3BB	ABP2 Series sensor with leadless SMT package, plastic single axial barbed pressure port, liquid media, food-grade silicone gel, no diagnostics, 1 psi gage pressure range, I^2C address 0x28, 10 % to 90 % of 2^{24} counts digital transfer function, 3.3 Vdc supply premounted on breakout board				
ABP2LSNT060PGSA3BB	ABP2 Series sensor with leadless SMT package, metal single axial straight barbless pressure port, liquid media, food-grade silicone gel, no diagnostics, 60 psi gage pressure range, SPI output type, 10 % to 90 % of 2^{24} counts digital transfer function, 3.3 Vdc supply premounted on breakout board				
ABP2LANT001BA2A3BB	ABP2 Series sensor with leadless SMT package, plastic single axial barbed pressure port, liquid media, food-grade silicone gel, no diagnostics, 1 bar absolute pressure range, $\rm I^2C$ address 0x28, 10 % to 90 % of 2^24 counts digital transfer function, 3.3 Vdc supply premounted on breakout board				
ABP2-BREAKOUT-BRD	Bare breakout board for use with SMT and leadless SMT packages with AN, SN, VN, NN, RN, or RR pressure ports				

SELECT ABP2 SERIES SENSORS MOUNTED ON BREAKOUT BOARDS (CONTINUED)

TABLE 11.	TABLE 11. BREAKOUT BOARD ASSEMBLY DETAILS						
SL Number	REF Designator	Description	Manufacturer Part Number	Populate	Description		
1	C1	Capacitor, ceramic, 0.1 μF, 16 V, X7R, 10 % SMD 0402	GCM155R71C104KA55J	Populated	A decoupling capacitor, breakout board shipped with this part assembled		
2	C2	Capacitor, ceramic SMD 0402	NA	DNP	Do not populate		
3	R1, R2	Resistor SMD 0402 SCL line/R1 and SDA line R2	NA	DNP	Optional pull-up resistors for I ² C output (not populated on the breakout board); recommended pull-up resistor value: 1 kOhm to 10 kOhm		
4	R3	Resistor, SMD 0402	NA	DNP	Jumper resistor, do not populate		
5	P1	Connector, header, 6 pin, straight, 2,54 mm pitch through hole	826629-6	Populated	6 pin connector		
6	U1	ABP2 sensor	ABP2	Populated	Respective ABP2 sensor mounted		

TABLE 12. BREAKOUT BOARD PINOUTS								
Pin Number	I ² C Output	SPI Output						
1	V_{DD}	V_{DD}						
2	SCL	SCLK						
3	EOC	MISO						
4	SDA	MOSI						
5	GND	GND						
6	NC	SS						

TABLE 13	. PRES	SURE	RANG	E SPECII	FICAT <u>I</u>	ONS: 6 N	IBAR TO) 12 BAR F	OR PRO	DUCT	OPTIO	NS "N", <u>"</u>	D", "T" AND	"V" ONLY
	Pres	sure nge		Overpre		Burst Pi		Common		al Error B (% FSS)		Typical Offset	Long-term	Transfer
Pressure Range	P _{Min.}	P _{Max.}	Unit	Port 1 (P1)	Port 2 (P2)	Port 1 (P1)	Port 2 (P2)	Mode Pressure ³	0°C to 50°C	-20°C to 85°C	-40°C to 110°C	Shift with Reflow (% FSS)	Stability (1000 HR) (% FSS)	Function for Digital Versions
							Abs	olute						
001BA	0	1	bar	16	-	25	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А
1.6BA	0	1.6	bar	16	_	25	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А
2.5BA	0	2.5	bar	16	-	25	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	А
							Diffe	rential						
2.5MD	-2.5	2.5	mbar	340	340	1020	510	-	±2.5	-	-	±1.0	±0.3	А
006MD	-6	6	mbar	340	340	1020	510	_	±2.5	_	_	±1.0	±0.3	Α
010MD	-10	10	mbar	340	340	1020	510	_	±2.5	-	-	±1.0	±0.3	A
016MD 025MD	-16 -25	16 25	mbar	700	700 700	7000 7000	1000	_	±2.0 ±2.0	±3.5	-	±1.0 ±1.0	±0.3	Α
025MD 040MD ⁵	-40	40	mbar	700	1000	7000	1000	2000	±2.0	±3.5 ±3.0	+4.5	NA NA	±0.3	A
060MD⁵	-60	60	mbar	2000	1000	7000	2000	2000	±1.5	±3.0	±4.5	NA	±0.2	A
100MD ⁵	-100	100	mbar	2000	1000	7000	2000	2000	±1.5	±3.0	±4.5	NA	±0.2	A
160MD⁵	-160	160	mbar	2000	1000	7000	2000	2000	±1.5	±3.0	±4.5	NA	±0.2	А
250MD	-250	250	mbar	16000	-	25000	_	16000	±1.5	±3.0	±4.5	±1.0	±0.6	А
400MD	-400	400	mbar	16000	_	25000	_	16000	±1.5	±3.0	±4.5	±1.0	±0.6	А
600MD	-600	600	mbar	16000	-	25000	_	16000	±1.5	±3.0	±4.5	±1.0	±0.6	А
001BD	-1	1	bar	16	-	25	-	16	±1.5	±3.0	±4.5	±1.0	±0.2	А
1.6BD	-1.6	1.6	bar	16	-	25	_	16	±1.5	±3.0	±4.5	±1.0	±0.2	А
2.5BD	-2.5	2.5	bar	16	-	25	-	16	±1.5	±3.0	±4.5	±1.0	±0.2	А
004BD	-4	4	bar	16	_	25	-	16	±1.5	±3.0	±4.5	±1.0	±0.2	А
006МG	0	6	ua la a u	340		1020		age	. 2 5			.1.0	.0.2	٨
010MG	0	10	mbar	340	_	1020	_	_	±2.5	_	_	±1.0 ±1.0	±0.3	A
016MG	0	16	mbar	340	_	1020	_	_	±2.5	_	_	±1.0	±0.3	A
025MG	0	25	mbar	700	_	7000	_	_	±2.0	±3.5	_	±1.0	±0.3	A
040MG	0	40	mbar	700	_	7000	_	_	±2.0	±3.5	_	±1.0	±0.3	А
060MG⁵	0	60	mbar	2000	-	7000	-	_	±1.5	±3.0	±4.5	NA	±0.2	А
100MG⁵	0	100	mbar	2000	_	7000	_	-	±1.5	±3.0	±4.5	NA	±0.2	Α
160MG ⁵	0	160	mbar	2000	_	7000	_	_	±1.5	±3.0	±4.5	NA	±0.2	А
250MG⁵	0	250	mbar	2000	-	7000	-	-	±1.5	±3.0	±4.5	NA	±0.2	Α
400MG⁵	0	400	mbar	2000	_	7000	-	_	±1.5	±3.0	±4.5	NA	±0.2	А
600MG	0	600	mbar	16000	-	25000	_	-	±1.5	±3.0	±4.5	±1.0	±0.6	Α
001BG	0	1	bar	16	_	25	-	_	±1.5	±3.0	±4.5	±1.0	±0.5	A
1.6BG	0	1.6	bar	16	_	25	_	_	±1.5	±3.0	±4.5	±1.0	±0.3	A
2.5BG	0	2.5	bar	16	_	25	-	_	±1.5	±3.0	±4.5	±1.0	±0.2	A
004BG 006BG	0	6	bar	16	_	25 25	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	A
008BG	0	8	bar bar	16 16	_	25	_	_	±1.5 ±1.5	±3.0 ±3.0	±4.5 ±4.5	±1.0 ±1.0	±0.2 ±0.2	A
010BG	0	10	bar	16	_	25	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	A
010BG	0	12	bar	16	_	25	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	A

¹ Overpressure: The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified, this applies to all available pressure ports at any

temperature within the operating temperature range.

2 Burst Pressure: The maximum pressure that may be applied to any port of the product without causing escape of pressure media. The product should not be expected to function after exposure to any pressure beyond the burst pressure.

³ Common Mode Pressure: The maximum pressure that can be applied simultaneously to both ports of a differential pressure sensor without causing changes in specified performance.

⁴Total Error Band: The maximum deviation from the ideal transfer function over the entire compensated temperature and pressure range without causing changes in specified performance.

⁵Total Error Band specified for these pressure ranges are after offset auto-zero correction post sensor reflow.

TABLE 14	4. PRE	SSURI	ERAN	GE SPE	CIFICA'	TIONS:	250 ME	AR TO 12 E	BAR FO	R PRO	DUCT	PTIONS	G"G" AND "I	"ONLY
		sure nge		Overpr	essure¹	Burst P	ressure²	Common	Tota	al Error B (% FSS)	and ⁴	Typical Offset	Long-term	Transfer
Pressure Range	P _{Min.}	P _{Max.}	Unit	Port 1 (P1)	Port 2 (P2)	Port 1 (P1)	Port 2 (P2)	Mode Pressure ³	0°C to 50°C	-20°C to 85°C	-40°C to 110°C	Shift with Reflow (% FSS)	Stability (1000 HR) (% FSS)	Function for Digital Versions
							Ak	solute						
001BA	0	1	bar	16	_	25	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
1.6BA	0	1.6	bar	16	-	25	-	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
2.5BA	0	2.5	bar	16	_	25	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
004BA	0	4	bar	16	_	25	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
006BA	0	6	bar	16	_	25	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
008BA	0	8	bar	16	_	25	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
010BA	0	10	bar	16	_	25	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
012BA	0	12	bar	16	_	25	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
							Diff	ferential						
250MD	-250	250	mbar	16000	_	25000	_	16000	±2.0	±3.0	±4.5	±1.0	±0.5	Α
400MD	-400	400	mbar	16000	_	25000	_	16000	±2.0	±3.0	±4.5	±1.0	±0.5	Α
600MD	-600	600	mbar	16000	_	25000	_	16000	±2.0	±3.0	±4.5	±1.0	±0.5	Α
001BD	-1	1	bar	16	_	25	_	16	±2.0	±3.0	±4.5	±1.0	±0.5	Α
1.6BD	-1.6	1.6	bar	16	_	25	_	16	±2.0	±3.0	±4.5	±1.0	±0.5	Α
2.5BD	-2.5	2.5	bar	16	_	25	_	16	±2.0	±3.0	±4.5	±1.0	±0.5	Α
004BD	-4	4	bar	16	_	25	_	16	±2.0	±3.0	±4.5	±1.0	±0.5	Α
							(Gage						
600MG	0	600	mbar	16000	_	25000	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
001BG	0	1	bar	16	-	25	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
1.5BG	0	1.6	bar	16	_	25	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
2.5BG	0	2.5	bar	16	_	25	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
004BG	0	4	bar	16	_	25	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
006BG	0	6	bar	16	-	25	-	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
008BG	0	8	bar	16	_	25	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
010BG	0	10	bar	16	_	25	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
012BG	0	12	bar	16	_	25	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α

¹ Overpressure: The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified, this applies to all available pressure ports at any temperature within the operating temperature range.

² Burst Pressure: The maximum pressure that may be applied to any port of the product without causing escape of pressure media. The product should not be expected to function after exposure to any pressure beyond the burst pressure.

³ Common Mode Pressure: The maximum pressure that can be applied simultaneously to both ports of a differential pressure sensor without causing changes in specified performance.

⁴Total Error Band: The maximum deviation from the ideal transfer function over the entire compensated temperature and pressure range without causing changes in specified performance.

TABLE 1	L5. PRE	SSURI	E RAN	GE SPE	CIFICAT	TIONS: 6	00 PA T <u>O</u>	1.2 MPA FO	OR PRO	DUCT	OPTION	IS "N", " <u>D</u>	", "T" AND "	V" ONLY
		sure		Overpr	essure ¹	Burst P	ressure ²		Tot	al Error B		Typical		
Pressure	Raı	nge			 			Common		(% FSS)		Offset Shift	Long-term Stability	Transfer Function
Range		 	Unit	Port 1	Port 2	Port 1	Port 2	Mode Pressure ³	0°C to	-20°C to	-40°C to	with	(1000 HR)	for Digital
	P _{Min.}	P _{Max.}		(P1)	(P2)	(P1)	(P2)	Flessule	50°C	85°C	110°C	Reflow (% FSS)	(% FSS)	Versions
							Ab	solute				(70 F33)		
100KA	0	100	kPa	1600	-	2500	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	Α
160KA	0	160	kPa	1600	_	2500	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	Α
250KA	0	250	kPa	1600	-	2500	_	-	±1.5	±3.0	±4.5	±1.0	±0.2	Α
							Diff	erential						
250LD	-250	250	Pa	34000	34000	100000	50000	-	±2.5	-	-	±1.0	±0.3	Α
600LD	-600	600	Pa	34000	34000	100000	50000	-	±2.5	_	_	±1.0	±0.3	Α
001KD	-1	1	kPa	34	34	100	50	-	±2.5	-	-	±1.0	±0.3	Α
1.6KD	-1.6	1.6	kPa	70	70	700	100	_	±2.0	±3.5	_	±1.0	±0.3	Α
2.5KD	-2.5	2.5	kPa	70	70	700	100	-	±2.0	±3.5	_	±1.0	±0.3	A
004KD ⁵	-4	4	kPa	200	100	700	200	200	±1.5	±3.0	±4.5	NA	±0.2	Α .
006KD5	-6	6	kPa	200	100	700	200	200	±1.5	±3.0	±4.5	NA	±0.2	A
010KD ⁵	-10	10	kPa	200	100	700	200	200	±1.5	±3.0	±4.5	NA	±0.2	A
016KD5	-16	16	kPa	200	100	700	200	200	±1.5	±3.0	±4.5	NA .1.0	±0.2	A
025KD	-25	25	kPa	1600	_	2500	_	16000	±1.5	±3.0	±4.5	±1.0	±0.6	A
040KD	-40	40 60	kPa	1600	_	2500	_	16000	±1.5	±3.0	±4.5	±1.0	±0.6	A
060KD 100KD	-60 -100	100	kPa kPa	1600 1600	_	2500 2500	_	16000 16000	±1.5 ±1.5	±3.0 ±3.0	±4.5 ±4.5	±1.0 ±1.0	±0.6 ±0.2	A
160KD	-160	160	kPa	1600	_	2500	_	16000	±1.5	±3.0	±4.5	±1.0	±0.2	A
250KD	-250	250	kPa	1600	_	2500	_	16000	±1.5	±3.0	±4.5	±1.0	±0.2	Α
400KD	-400	400	kPa	1600	_	2500	_	16000	±1.5	±3.0	±4.5	±1.0	±0.2	Α
100112	.00	.00		2000		2000		iage		20.0			20.2	,,
600LG	0	600	Pa	34000	_	100000	_	_	±2.5	_	_	±1.0	±0.3	Α
001KG	0	1	kPa	34	_	100	_	_	±2.5	_	_	±1.0	±0.3	Α
1.6KG	0	1.6	kPa	34	_	100	_	_	±2.5	_	_	±1.0	±0.3	Α
2.5KG	0	2.5	kPa	70	_	700	_	_	±2.0	±3.5	_	±1.0	±0.3	Α
004KG	0	4	kPa	70	_	700	_	_	±2.0	±3.5	_	±1.0	±0.3	Α
006KG ⁵	0	6	kPa	200	-	700	-	-	±1.5	±3.0	±4.5	NA	±0.2	Α
010KG ⁵	0	10	kPa	200	_	700	_	_	±1.5	±3.0	±4.5	NA	±0.2	Α
016KG ⁵	0	16	kPa	200	_	700	_	-	±1.5	±3.0	±4.5	NA	±0.2	Α
025KG ⁵	0	25	kPa	200	_	700	_	_	±1.5	±3.0	±4.5	NA	±0.2	Α
040KG ⁵	0	40	kPa	200	_	700	_	_	±1.5	±3.0	±4.5	NA	±0.2	Α
060KG	0	60	kPa	1600	-	2500	-	-	±1.5	±3.0	±4.5	±1.0	±0.6	Α
100KG	0	100	kPa	1600	_	2500	_	-	±1.5	±3.0	±4.5	±1.0	±0.5	А
160KG	0	160	kPa	1600	-	2500	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	Α
250KG	0	250	kPa	1600	_	2500	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А
400KG	0	400	kPa	1600	-	2500	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	Α
600KG	0	600	kPa	1600	_	2500	_	-	±1.5	±3.0	±4.5	±1.0	±0.2	Α
800KG	0	800	kPa	1600	_	2500	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	A
001GG	0	1	MPa	1.6	_	2.5	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	А
1.2GG	0	1.2	MPa	1.6	-	2.5	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	Α

¹Overpressure: The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified, this applies to all available pressure ports at any temperature within the operating temperature range.

² Burst Pressure: The maximum pressure that may be applied to any port of the product without causing escape of pressure media. The product should not be expected to function after exposure to any pressure beyond the burst pressure.

³Common Mode Pressure: The maximum pressure that can be applied simultaneously to both ports of a differential pressure sensor without causing changes in specified performance.

4 Total Error Band: The maximum deviation from the ideal transfer function over the entire compensated temperature and pressure range without

causing changes in specified performance.

⁵Total Error Band specified for these pressure ranges are after offset auto-zero correction post sensor reflow.

TABLE 16. PRESSURE RANGE SPECIFICATIONS: 25 KPA TO 1.2 MPA FOR PRODUCT OPTIONS "G" AND "F" ONLY														
_		ssure nge		Overpr	essure¹	Burst P	ressure ²	Common	Tot	al Error B (% FSS)		Typical Offset	Long- term	Transfer
Pressure Range	P _{Min.}	P _{Max.}	Unit	Port 1 (P1)	Port 2 (P2)	Port 1 (P1)	Port 2 (P2)	Mode Pressure ³	0°C to 50°C	-20°C to 85°C	-40°C to 110°C	Shift with Reflow (% FSS)	Stability (1000 HR) (% FSS)	Function for Digital Versions
							Ab	solute						
100KA	0	100	kPa	1600	_	2500	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
160KA	0	160	kPa	1600	_	2500	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
250KA	0	250	kPa	1600	_	2500	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
400KG	0	400	kPa	1600	_	2500	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
600KG	0	600	kPa	1600	-	2500	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
800KG	0	800	kPa	1600	-	2500	-	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
001GG	0	1	MPa	1.6	-	2.5	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
1.2GG	0	1.2	MPa	1.6	_	2.5	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
							Diff	erential						
025KD	-25	25	kPa	1600	-	2500	-	1600	±2.0	±3.0	±4.5	±1.0	±0.5	Α
040KD	-40	40	kPa	1600	_	2500	_	1600	±2.0	±3.0	±4.5	±1.0	±0.5	Α
060KD	-60	60	kPa	1600	_	2500	_	1600	±2.0	±3.0	±4.5	±1.0	±0.5	Α
100KD	-100	100	kPa	1600	-	2500	-	1600	±2.0	±3.0	±4.5	±1.0	±0.5	Α
160KD	-160	160	kPa	1600	-	2500	-	1600	±2.0	±3.0	±4.5	±1.0	±0.5	Α
250KD	-250	250	kPa	1600	-	2500	_	1600	±2.0	±3.0	±4.5	±1.0	±0.5	Α
400KD	-400	400	kPa	1600	-	2500	-	1600	±2.0	±3.0	±4.5	±1.0	±0.5	Α
							C	Gage						
060KG	0	60	kPa	1600	_	2500	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
100KG	0	100	kPa	1600	_	2500	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
160KG	0	160	kPa	1600	_	2500	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
250KG	0	250	kPa	1600	_	2500	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
400KG	0	400	kPa	1600	_	2500	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
600KG	0	600	kPa	1600	_	2500	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
800KG	0	800	kPa	1600	_	2500	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
001GG	0	1	MPa	1.6	_	2.5	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
1.2GG	0	1.2	MPa	1.6	-	2.5	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α

¹ Overpressure: The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified, this applies to all available pressure ports at any temperature within the operating temperature range.

² Burst Pressure: The maximum pressure that may be applied to any port of the product without causing escape of pressure media. The product should not be expected to function after exposure to any pressure beyond the burst pressure.

³ Common Mode Pressure: The maximum pressure that can be applied simultaneously to both ports of a differential pressure sensor without causing changes in specified performance.

⁴Total Error Band: The maximum deviation from the ideal transfer function over the entire compensated temperature and pressure range without causing changes in specified performance.

TABLE 17. PRESSURE RANGE SPECIFICATIONS: 1PSI TO 175 PSI FOR PRODUCT OPTIONS "N","D","T" AND "V" ONLY PRESSURE RANGE SPECIFICATIONS: 2 INH₋0 TO 1 PSI FOR PRODUCT OPTIONS "N" AND "D" ONLY

		sure nge			essure¹		ressure²	Common		al Error B (% FSS)	Band ⁴	Typical Offset	Long-term	Transfer
Pressure Range	P _{Min.}	P _{Max.}	Unit	Port 1 (P1)	Port 2 (P2)	Port 1 (P1)	Port 2 (P2)	Mode Pressure ³	0°C to 50°C	-20°C to 85°C	-40°C to 110°C	Shift with Reflow (% FSS)	Stability (1000 HR) (% FSS)	Function for Digital Versions
							Ab	solute						
015PA	0	15	psi	240	-	375	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	А
030PA	0	30	psi	240	_	375	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	Α
							Diff	erential						
001ND	-1	1	inH_2O	135	135	410	205	-	±2.5	-	-	±1.0	±0.3	А
002ND	-2	2	inH ₂ 0	135	135	410	205	-	±2.5	-	-	±1.0	±0.3	А
004ND	-4	4	inH_2O	135	135	410	205	_	±2.5	_	_	±1.0	±0.3	Α
005ND	-5	5	inH_2O	270	270	2800	415	_	±2.0	±3.5	_	±1.0	±0.3	Α
010ND	-10	10	inH_2O	270	270	2800	415	_	±2.0	±3.5	_	±1.0	±0.3	Α
020ND ⁵	-20	20	inH_2O	830	415	2800	830	830	±1.5	±3.0	±4.5	NA	±0.2	Α
030ND⁵	-30	30	inH_2O	830	415	2800	830	830	±1.5	±3.0	±4.5	NA	±0.2	А
001PD⁵	-1	1	psi	30	15	100	30	30	±1.5	±3.0	±4.5	NA	±0.2	А
005PD	-5	5	psi	240	_	375	-	240	±1.5	±3.0	±4.5	±1.0	±0.6	А
015PD	-15	15	psi	240	-	375	-	240	±1.5	±3.0	±4.5	±1.0	±0.2	А
030PD	-30	30	psi	240	_	375	-	240	±2.0	±3.0	±4.5	±1.0	±0.2	Α
060PD	-60	60	psi	240	-	375	-	240	±2.0	±3.0	±4.5	±1.0	±0.2	А
								Gage						
002NG	0	2	inH ₂ 0	135	_	410	_	_	±2.5	_	_	±1.0	±0.3	Α
004NG	0	4	inH ₂ 0	135	_	410	_	_	±2.5	_	_	±1.0	±0.3	А
005NG	0	5	inH ₂ 0	135	_	410	_	_	±2.5	_	_	±1.0	±0.3	Α
010NG	0	10	inH ₂ 0	270	_	2800	-	_	±2.0	±3.5	_	±1.0	±0.3	Α
020NG	0	20	inH ₂ 0	270	_	2800	_	_	±2.0	±3.5	_	±1.0	±0.3	Α
030NG⁵	0	30	inH ₂ 0	830	_	2800	-	-	±1.5	±3.0	±4.5	NA	±0.2	Α
001PG⁵	0	1	psi	30	_	100	_	_	±1.5	±3.0	±4.5	NA	±0.2	Α
005PG⁵	0	5	psi	30	_	100	_	-	±1.5	±3.0	±4.5	NA	±0.2	Α
015PG	0	15	psi	240	_	375	_	_	±1.5	±3.0	±4.5	±1.0	±0.5	Α
030PG	0	30	psi	240	-	375	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	А
060PG	0	60	psi	240	_	375	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	Α
100PG	0	100	psi	240	-	375	-	-	±1.5	±3.0	±4.5	±1.0	±0.2	А
150PG	0	150	psi	240	_	375	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	Α
175PG	0	175	psi	240	_	375	_	_	±1.5	±3.0	±4.5	±1.0	±0.2	А

¹ Overpressure: The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified, this applies to all available pressure ports at any temperature within the operating temperature range.

² Burst Pressure: The maximum pressure that may be applied to any port of the product without causing escape of pressure media. The product should not be expected to function after exposure to any pressure beyond the burst pressure.

³ Common Mode Pressure: The maximum pressure that can be applied simultaneously to both ports of a differential pressure sensor without causing changes in specified performance.

⁴ Total Error Band: The maximum deviation from the ideal transfer function over the entire compensated temperature and pressure range without causing changes in specified performance.

⁵ Total Error Band specified for these pressure ranges are after offset auto-zero correction post sensor reflow.

TABLE 1	L8. PRI	ESSUF	RE RA	NGE SP	ECIFIC	ATIONS	: 5 PS I 1	TO 175 PSI	FOR PR	ODUC	T OPTI	ONS "G"	AND "F" ON	ILY
		sure nge		Overpr	essure¹	Burst P	ressure²	essure ² Common		al Error Band ⁴ (% FSS)		Typical Offset	Long-term	Transfer
Pressure Range	P _{Min.}	P _{Max.}	Unit	Port 1 (P1)	Port 2 (P2)	Port 1 (P1)	Port 2 (P2)	Mode Pressure ³	0°C to 50°C	-20°C to 85°C	-40°C to 110°C	Shift with Reflow (% FSS)	Stability (1000 HR) (% FSS)	Function for Digital Versions
							A	bsolute						
015PA	0	15	psi	240	-	375	-	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α
030PA	0	30	psi	240	_	375	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
060PA	0	60	psi	240	_	375	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
100PA	0	100	psi	240	_	375	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
150PA	0	150	psi	240	_	375	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
175PA	0	175	psi	240	_	375	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
							Dif	ferential						
005PD	-5	5	psi	240	-	375	_	240	±2.0	±3.0	±4.5	±1.0	±0.5	А
015PD	-15	15	psi	240	_	375	_	240	±2.0	±3.0	±4.5	±1.0	±0.5	Α
030PD	-30	30	psi	240	-	375	-	240	±2.0	±3.0	±4.5	±1.0	±0.5	А
060PD	-60	60	psi	240	_	375	_	240	±2.0	±3.0	±4.5	±1.0	±0.5	А
								Gage						
015PG	0	15	psi	240	-	375	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	А
030PG	0	30	psi	240	_	375	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	А
060PG	0	60	psi	240	_	375	-	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
100PG	0	100	psi	240	_	375	_	_	±2.0	±3.0	±4.5	±1.0	±0.5	Α
150PG	0	150	psi	240	_	375	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	А
175PG	0	175	psi	240	_	375	_	-	±2.0	±3.0	±4.5	±1.0	±0.5	Α

 $^{^1}$ Overpressure: The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified, this applies to all available pressure ports at any temperature within the operating temperature range.

² Burst Pressure: The maximum pressure that may be applied to any port of the product without causing escape of pressure media. The product should not be expected to function after exposure to any pressure beyond the burst pressure.

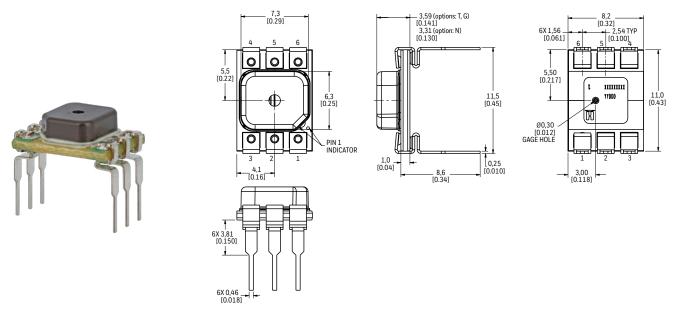
³ Common Mode Pressure: The maximum pressure that can be applied simultaneously to both ports of a differential pressure sensor without causing changes in specified performance.

⁴ Total Error Band: The maximum deviation from the ideal transfer function over the entire compensated temperature and pressure range without causing changes in specified performance.

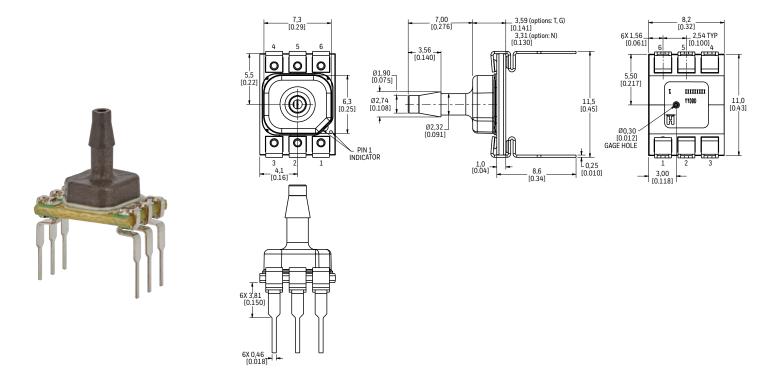
ABP2 SERIES

Figure 9. DIP Package Dimensional Drawings (For reference only: mm [in].)

DIP NN: Plastic no port



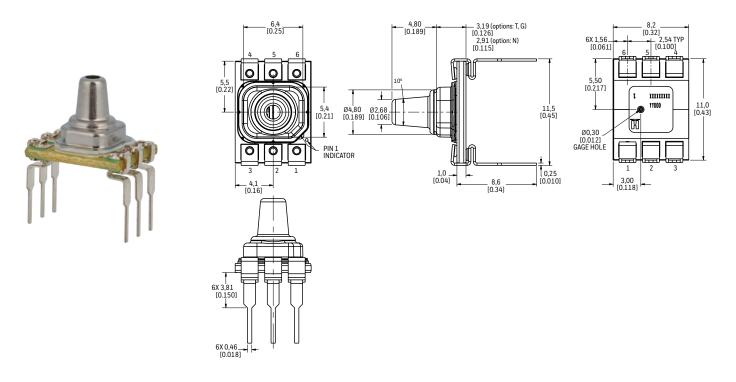
DIP AN: Plastic single axial barbed port



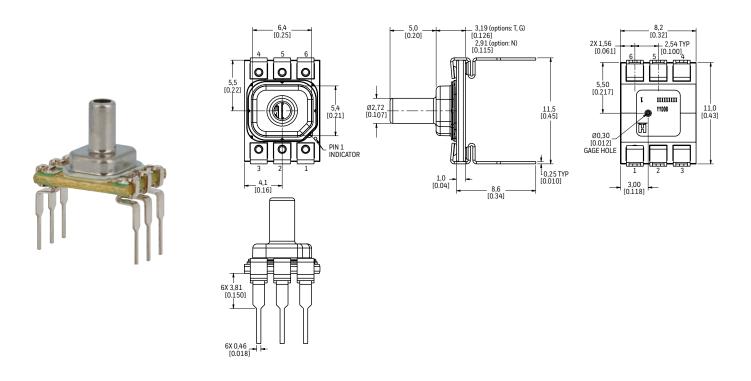
ABP2 SERIES

Figure 9. DIP Package Dimensional Drawings (Continued)

DIP VN: Metal single axial barbless port



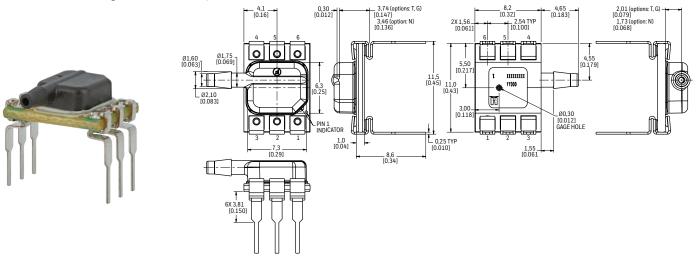
DIP SN: Metal single axial straight barbless port



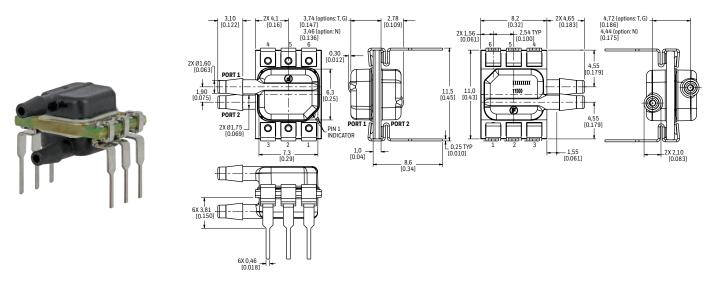
ABP2 SERIES

Figure 9. DIP Package Dimensional Drawings (Continued)

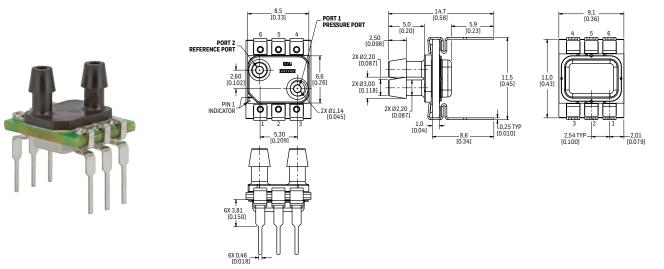
DIP RN: Plastic single radial barbed port



DIP RR: Plastic dual radial barbed ports, same side



DIP DA: Plastic dual axial barbed ports, same side

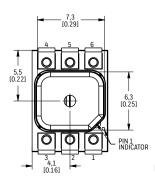


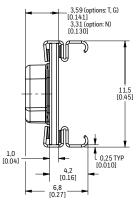
ABP2 SERIES

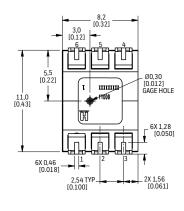
Figure 10. SMT Package Dimensional Drawings (For reference only: mm [in].)

SMT NN: Plastic no port



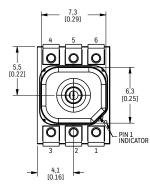


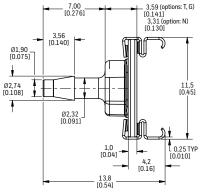


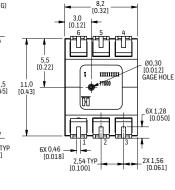


SMT AN: Plastic single axial barbed port



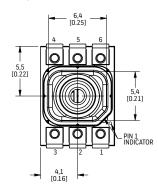


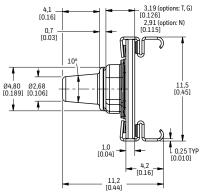


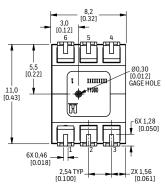


SMT VN: Metal single axial barbless port



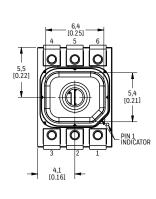


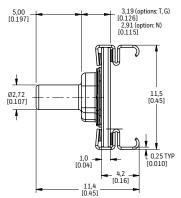


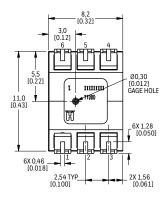


SMT SN: Metal single axial straight barbless port





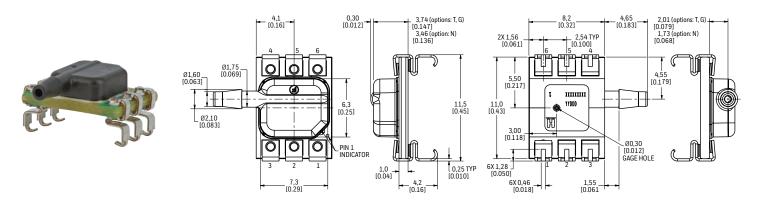




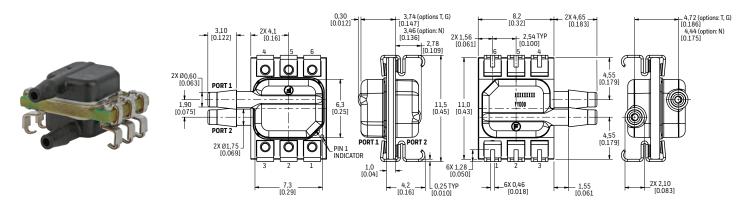
ABP2 SERIES

Figure 10. SMT Package Dimensional Drawings (Continued)

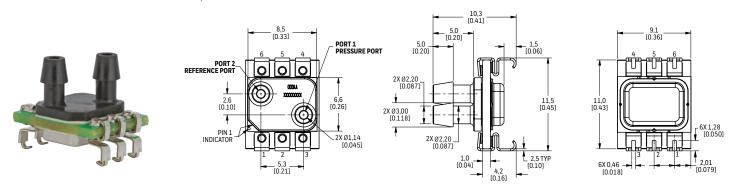
SMT RN: Plastic single radial barbed port



SMT RR: Plastic dual radial barbed ports, same side



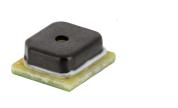
SMT DA: Plastic dual axial barbed ports, same side

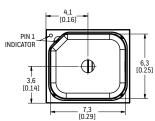


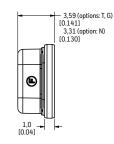
ABP2 SERIES

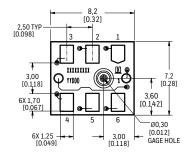
Figure 11. Leadless SMT Package Dimensional Drawings (For Reference Only: mm [in].)

Leadless SMT NN: Plastic no port



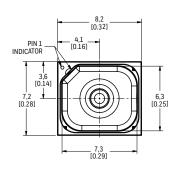


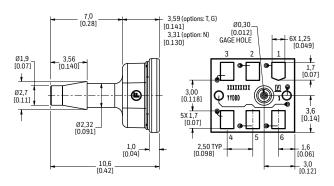




Leadless SMT AN: Plastic single axial barbed port

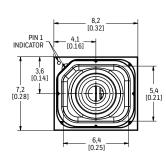


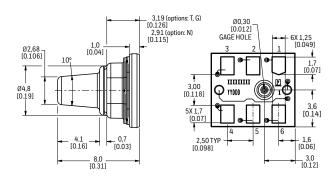




Leadless SMT VN: Metal single axial barbless port

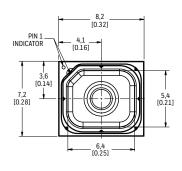


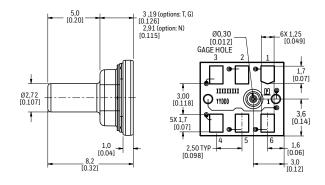




Leadless SMT SN: Metal single axial straight port





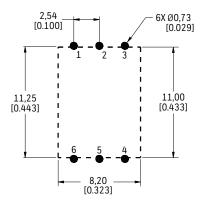


ABP2 SERIES

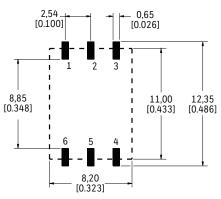
TABLE 19. PINOUT	·					
Output Type	Pin 1	Pin 2	Pin 3	Pin 4	Pin 5	Pin 6
I ² C	GND	V_{DD}	EOC	NC	SDA	SCL
SPI	GND	V_{DD}	MISO	SS	MOSI	SCLK
Analog	GND	NC	V_{OUT}	NC	NC	V_{DD}

Figure 12. Recommended PCB Layout and Part Marketing Details

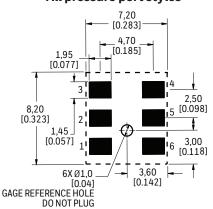
DIP Packages All pressure port styles except DA



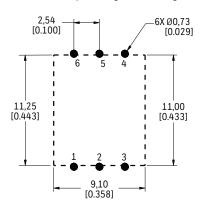
SMT Packages All pressure port styles except DA



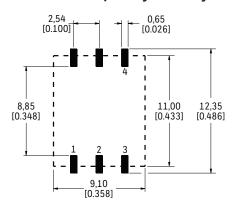
Leadless SMT Packages All pressure port styles



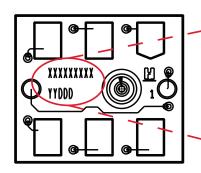
DIP Packages Pressure port style DA only



DMT Packages Pressure port style DA only



Part Marking Details



CATALOG LISTING: 'XXXXXXXXX'

EXAMPLE: N010BAA3

N - DRY GASES ONLY NO DIAGNOSTICS, 010B - 10bar, A - ABSOLUTE, A - ANALOG,

A - 10 % to 90 % of 2^24 COUNTS (DIGITAL). 3 - 3.3Vdc

DATE CODE: 'YYDDD' EXAMPLE: 19215

19 - YY - YEAR, 215 - DDD - JULIAN DAY.

1.0 **GENERAL INFORMATION**

Please see Figures 7, 8, and 9 for product dimensions and pinout details.

2.0 PINOUT AND FUNCTIONALITY

TABLE 20	TABLE 20. PINOUT AND FUNCTIONALITY										
Pad	I ² C Senso	or	SPI Sens	or							
Number	Name	Description	Name	Description							
1	GND	Ground reference voltage signal	GND	Ground reference voltage signal							
2	V_{DD}	Positive supply voltage	V_{DD}	Positive supply voltage							
3	EOC¹	End-of-conversion indicator: This pin is set high when a measurement and calculation have been completed and the data is ready to be clocked out	MISO	Master In/Sensor Out: Data output							
4	NC	No connection	SS	Sensor Select: Chip select							
5	SDA	Data in/out	MOSI	Master Out/Sensor In: Data in							
6	SCL	Clockinput	SCLK	Clock input							

¹ For more details on EOC functionality, please refer to the technical note.

3.0 **START-UP TIMING**

On power-up, the ABP2 Series digital sensor is able to receive the first command after 2.5 ms from when the V_{DD} supply is within operating specifications.

4.0 **POWER SUPPLY REQUIREMENT**

Verify that system power to the sensor meets the V_{DD} rising slope requirement (minimum V_{DD} rising slope is at least 10 V/ms).

ABP2 SERIES

5.0 REFERENCE CIRCUIT DESIGNS

DIGITAL OUTPUT VERSIONS 5.1

Figure 13. I²C SPI Circuit Diagram

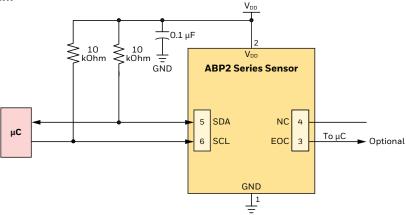
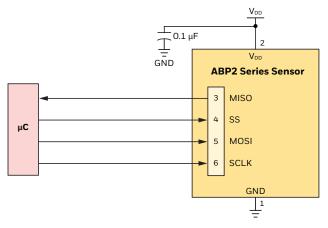
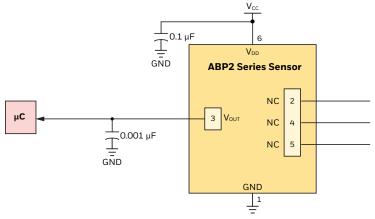


Figure 14. SPI Circuit Diagram



5.2 **ANALOG OUPUT VERSIONS**

Figure 15. Analog Circuit Diagram



BYPASS CAPACITOR USE 5.3

NOTICE

To ensure output noise suppression, place an external bypass capacitor of 0.1 μF very close to the sensor power supply pin (see Figures 13 and 14) in the end-user design.

6.0 I²C COMMUNICATIONS

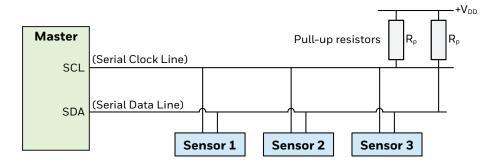
6.1 I²C BUS CONFIGURATION (SEE FIGURE 16.)

The I²C bus is a simple, serial 8-bit oriented computer bus for efficient I²C (Inter-IC) control. It provides good support for communication between different ICs across short circuit-board distances, such as interfacing microcontrollers with various low speed peripheral devices. For detailed specifications of the I²C protocol, see Version 6 (April 2014) of the I²C Bus Specification (source: NXP Semiconductor at https://www.nxp.com/docs/en/user-guide/UM10204.pdf).

Each device connected to the bus is software addressable by a unique address and a simple Master/Sensor relationship that exists at all times. The output stages of devices connected to the bus are designed around an open collector architecture. Because of this, pull-up resistors to $+V_{DD}$ must be provided on the bus. Both SDA and SCL are bidirectional lines, and it is important to system performance to match the capacitive loads on both lines. In addition, in accordance with the I²C specification, the maximum allowable capacitance on either line is 400 pF to ensure reliable edge transitions at 400 kHz clock speeds.

When the bus is free, both lines are pulled up to $+V_{DD}$. Data on the I^2C bus can be transferred at a rate up to 100 kbit/s in the standard-mode, or up to 400 kbit/s in the fast-mode.

Figure 16. I²C Bus Configuration



6.2 I²C DATA TRANSFER

The ABP2 Series I²C sensors are designed to respond to requests from a Master device. Following the address and read bit from the Master, the ABP2 Series digital output pressure sensors are designed to output up to 7 bytes of data. The first data byte is the Status Byte (8 bit), the second to fourth bytes are the compensated pressure output (24 bit) and the fifth to seventh bytes are the compensated temperature output (24 bit).

6.3 I²C SENSOR ADDRESS

Each ABP2 Series I²C sensor is referenced on the bus by a 7-bit Sensor address. The default address for the ABP2 Series is 40 (28 hex). Other available standard addresses are: 08 (08 hex), 24 (18 hex), 56 (38 hex), 72 (48 hex), 88 (58 hex), 104 (68 hex), 120 (78 hex). (Other custom values are available. Please contact Honeywell Customer Service with questions regarding custom Sensor addresses.)

6.4 I²C PRESSURE AND TEMPERATURE READING

To read out the compensated pressure and temperature reading, the Master generates a START condition and sends the Sensor address followed by a read bit (1). After the Sensor generates an acknowledge, it will transmit up to 7 bytes of data. The first data byte is the Status Byte (8-bit) and the second to fourth bytes are the compensated pressure output (24 bit) and the fifth to seventh bytes are the compensated temperature output (24 bit). The Master must acknowledge the receipt of each byte, and can terminate the communication by sending a Not Acknowledge (NACK) bit followed by a Stop bit after receiving the required bytes of data.

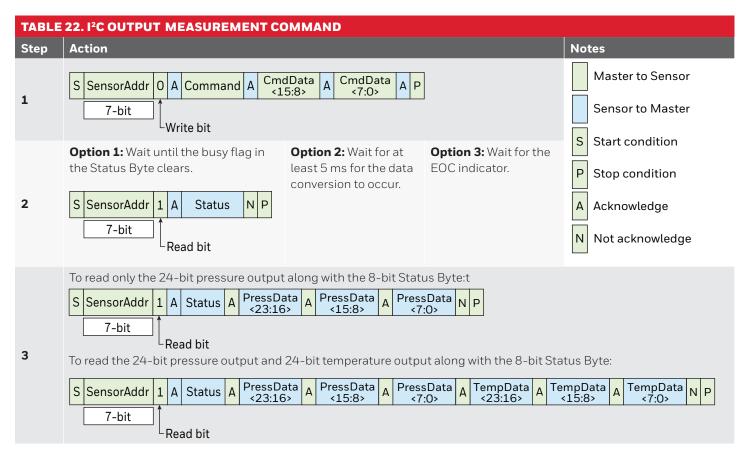
6.5 I²C STATUS BYTE

TABLE 21. I ² C STATUS BYTE I	TABLE 21. I ² C STATUS BYTE EXPLANATION									
BIT (Meaning)	Status	Comment								
7	Always O	-								
6 (Power indication)	1 = device is powered 0 = device is not powered	_								
5 (Busy flag)	1 = device is busy	Indicates that the data for the last command is not yet available. No new commands are processed if the device is busy.								
4	Always O	_								
3	Always 0	_								
2 (Memory integrity/error flag)	O = integrity test passed 1 = integrity test failed	Indicates whether the checksum-based integrity check passed or failed; the memory error status bit is calculated only during the power-up sequence.								
1	Always 0	-								
0 (Math saturation)	1 = internal math saturation has occurred	_								

6.6 I²C COMMUNICATIONS

6.6.1 I²C OUTPUT MEASUREMENT COMMAND

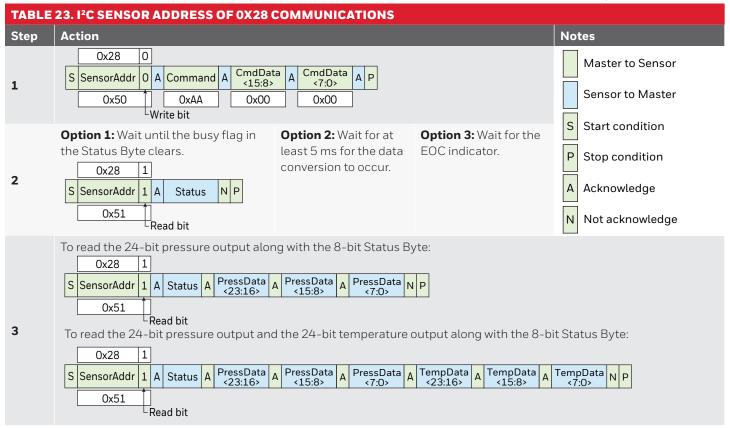
To communicate with the ABP2 Series I^2C output sensor using an Output Measurement Command of "0xAA", followed by "0x00" "0x00", follow the steps shown in Table 22. This command will cause the device to exit Standby Mode and enter Operating Mode. At the conclusion of the measurement cycle, the device will automatically re-enter Standby Mode.



ABP2 SERIES

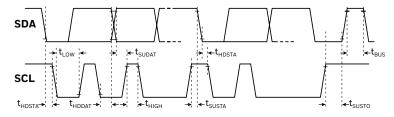
6.6.2 I²C SENSOR ADDRESS OF 0X28

To communicate with the ABP2 Series I^2 C output sensor with an I^2 C Sensor Address of 0x28 (hex), follow the steps shown in Table 23.



6.7 I²C TIMING AND LEVEL PARAMETERS

TABLE 24. I²C BUS TIMING DIAGRAM AND PARAMETERS



Characteristic	Abbreviation	Min.	Тур.	Max.	Unit
SCL clock frequency	f _{SCL}	100	_	400	kHz
Start condition hold time relative to SCL edge	t _{HDSTA}	0.1	_	_	μs
Minimum SCL clock low width ¹	t _{LOW}	0.6	_	_	μs
Minimum SCL clock high width ¹	t _{HIGH}	0.6	_	_	μs
Start condition setup time relative to SCL edge	t _{SUSTA}	0.1	_	_	μs
Data hold time on SDA relative to SCL edge	t _{HDDAT}	0	_	_	μs
Data setup time on SDA relative to SCL edge	t _{SUDAT}	0.1	_	_	μs
Stop condition setup time on SCL	t _{susto}	0.1	_	_	μs
Bus free time between stop condition and start condition	t _{BUS}	2	_	_	μs
Output level low	Out _{low}	_	0	0.2	V_{DD}
Output level high	Out _{high}	0.8	1	_	V_{DD}
Pull-up resistance on SDA and SCL	R_p	1	_	50	kOhm

 $^{^{\}rm 1}{\rm Combined}$ low and high widths must equal or exceed minimum SCL period.

6.8 REFERENCE CODE (ARDUINO/GENUINO UNO) FOR I²C INTERFACE

See also Section 8.0 for details and examples of ABP2 Series Pressure and Temperature output calculations.

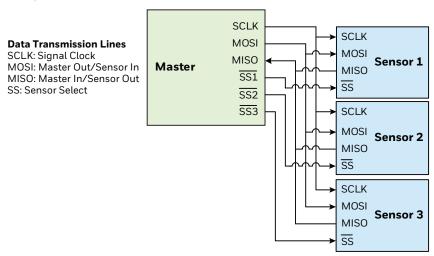
```
#include<Arduino.h>
#include<Wire.h>
uint8_t id = 0x28; // i2c address
uint8_t data[7]; // holds output data
uint8_t cmd[3] = \{0xAA, 0x00, 0x00\}; // command to be sent
double press counts = 0; // digital pressure reading [counts]
double temp counts = 0; // digital temperature reading [counts]
double pressure = 0; // pressure reading [bar, psi, kPa, etc.]
double temperature = 0; // temperature reading in deg C
double outputmax = 15099494; // output at maximum pressure [counts]
double outputmin = 1677722; // output at minimum pressure [counts]
double pmax = 1; // maximum value of pressure range [bar, psi, kPa, etc.]
double pmin = 0; // minimum value of pressure range [bar, psi, kPa, etc.]
double percentage = 0; // holds percentage of full scale data
char printBuffer[200], cBuff[20], percBuff[20], pBuff[20], tBuff[20];
void setup() {
  Serial.begin(9600);
  while (!Serial) {
    delay(10);
  Wire.begin();
  sprintf(printBuffer, "\nStatus Register, 24 - bit Sensor data, Digital Pressure Counts,\
           Percentage of full scale pressure, Pressure Output, Temperature\n");
  Serial.println(printBuffer);
void loop() {
  Wire.beginTransmission(id);
  int stat = Wire.write (cmd, 3); // write command to the sensor
  stat |= Wire.endTransmission();
  delay(10);
  Wire.requestFrom(id, 7); // read back Sensor data 7 bytes
  int i = 0;
  for (i = 0; i < 7; i++) {
    data [i] = Wire.read();
  press_counts = (double)((int32_t)data[3]+(int32_t)data[2]*(int32_t)256+
  (int32_t)data[1]*(int32_t)65536); // calculate digital pressure counts
  temp_counts = (double)((int32_t)data[6]+(int32_t)data[5]*(int32_t)256+
  (int32_t)data[4]*(int32_t)65536); // calculate digital temperature counts
  temperature = (temp counts * 200 / 16777215) - 50; // calculate temperature in deg c
  percentage = (press counts / 16777215) * 100; // calculate pressure as percentage of full scale
  //calculation of pressure value according to equation 2 of datasheet
  pressure = ((press counts - outputmin) * (pmax - pmin)) / (outputmax - outputmin) + pmin;
  dtostrf(press counts, 4, 1, cBuff);
  dtostrf(percentage, 4, 3, percBuff);
  dtostrf(pressure, 4, 3, pBuff);
  dtostrf(temperature, 4, 3, tBuff);
    The below code prints the raw data as well as the processed data
    Data format : Status Register, 24-bit Sensor Data, Digital Counts, percentage of full scale
pressure,
    pressure output, temperature
  sprintf(printBuffer, " % x\t % 2x % 2x % 2x\t % s\t % s\t % s\t % s\n", data[0], data[1], data[2],
          data[3].
          cBuff, percBuff, pBuff, tBuff);
  Serial.print(printBuffer);
  delay(10);
}
```

7.0 SPI COMMUNICATIONS

7.1 **SPI DEFINITION**

The Serial Peripheral Interface (SPI) is a simple bus system for synchronous serial communication between one Master and one or more Sensors. It operates either in full-duplex or half-duplex mode, allowing communication to occur in either both directions simultaneously, or in one direction only. The Master device initiates an information transfer on the bus and generates clock and control signals. Sensor devices are controlled by the Master through individual Sensors Select (SS) lines and are active only when selected. The ABP2 Series SPI sensors operate in full-duplex mode only, with data transfer from the Sensors to the Master. This data transmission uses four, unidirectional bus lines. The Master controls SCLK, MOSI and SS; the Sensor controls MISO. (See Figure 17.)

Figure 17. SPI Bus Configuration



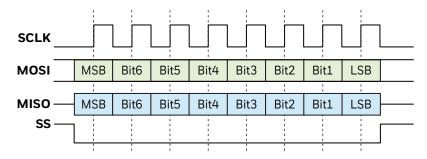
IMPORTANT:

If more than one ABP2 sensor, or other SPI slave devices, or more than one Master, are connected to the same SPI bus, before very first transaction on the SPI bus, bring SS line of each ABP2 sensor from High state to Low state, hold the Low state for minimum of 200 us, and release it to High state.

7.2 **SPI DATA TRANSFER**

Communicate with the ABP2 Series SPI sensors by de-asserting the Sensor Select (SS) line. At this point, the sensor is no longer idle, and will begin sending data once a clock is received. ABP2 Series SPI sensors are configured for SPI operation in mode 0 (clock polarity is 0 and clock phase is 0). (See Figure 18.)

Figure 18. Example of 1 Byte SPI Data Transfer



Once the clocking begins, the ABP2 Series SPI sensor is designed to output up to 7 bytes of data. The first data byte is the Status Byte (8-bit), the second to fourth bytes are the compensated pressure output (24-bit) and the fifth to seventh bytes are the compensated temperature output (24-bit).

7.3 SPI PRESSURE AND TEMPERATURE READING

To read out the compensated pressure and temperature reading, the Master generates the necessary clock signal after activating the sensor with the Sensor Select (SS) line. The sensor will transmit up to 7 bytes of data. The first data byte is the Status Byte (8-bit), the second to fourth bytes are the compensated pressure output (24-bit) and the fifth to seventh bytes are the compensated temperature output (24-bit). The Master can terminate the communication by stopping the clock and deactivating the SS line.

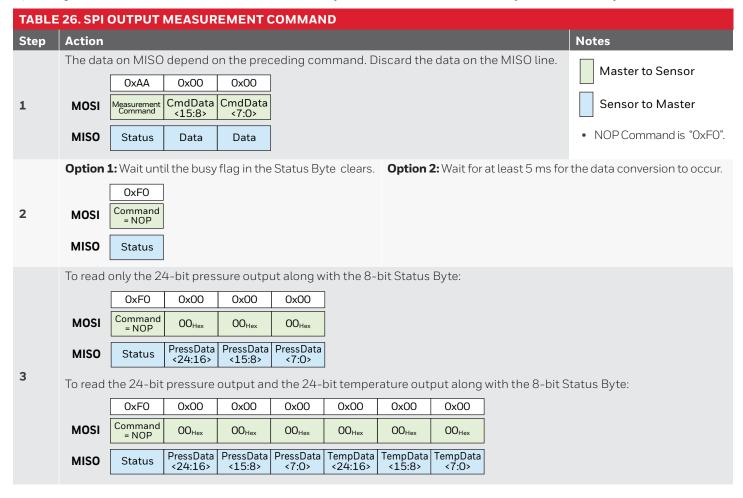
SPI STATUS BYTE 7.4

The SPI status byte contains the bits shown in Table 25.

TABLE 25. SPI STATUS BYTE E	EXPLANATION	
Bit (Meaning)	Status	Comment
7	Always 0	_
6 (Power indication)	1 = device is powered 0 = device is not powered	_
5 (Busy flag)	1 = device is busy	Indicates that the data for the last command is not yet available. No new commands are processed if the device is busy.
4	Always 0	_
3	Always 0	_
2 (Memory integrity/error flag)	0 = integrity test passed 1 = integrity test failed	Indicates whether the checksum-based integrity check passed or failed; the memory error status bit is calculated only during the power-up sequence.
1	Always 0	_
0 (Math saturation)	1 = internal math saturation has occurred	_

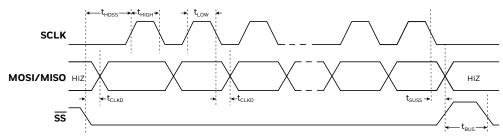
7.5 **SPI COMMUNICATION**

To communicate with the ABP2 Series SPI output sensor using an Output Measurement Command of "OxAA", followed by "0x00" "0x00", follow the steps shown in Table 26. This command will cause the device to exit Standby Mode and enter Operating Mode. At the conclusion of the measurement cycle, the device will automatically re-enter Standby Mode.



7.6 **SPI TIMING AND LEVEL PARAMETERS**

TABLE 27. SPI BUS TIMING DIAGRAM AND PARAMETERS



Characteristic	Abbreviation	Min.	Тур.	Max.	Unit
SCLK clock frequency	f _{SCLK}	50	_	800	kHz
SS drop to first clock edge	t _{HDSS}	2.5	_	_	μs
Minimum SCLK clock low width ¹	t _{LOW}	0.6	_	_	μs
Minimum SCLK clock high width ¹	t _{HIGH}	0.6	_	_	μs
Clock edge to data transition	t _{CLKD}	0	_	_	μs
Rise of SS relative to last clock edge	t _{suss}	0.1	_	_	μs
Bus free time between rise and fall of SS	t _{BUS}	2	_	_	μs
Output level low	Out _{low}	_	0	0.2	V_{DD}
Output level high	Out _{high}	0.8	1	_	V_{DD}

 $^{^{1}}$ Combined low and high widths must equal or exceed minimum SCLK period.

77 REFERENCE CODE (ARDUINO/GENUINO UNO) FOR SPI INTERFACE

See also Section 8.0 for details and examples of ABP2 Series Pressure and Temperature output calculations.

```
#include<Arduino.h>
#include<SPI.h>
double press_counts = 0; // digital pressure reading [counts]
double temp_counts = 0; // digital temperature reading [counts]
double pressure = 0; // pressure reading [bar, psi, kPa, etc.]
double temperature = 0; // temperature reading in deg C
double outputmax = 15099494; // output at maximum pressure [counts]
double outputmin = 1677722; // output at minimum pressure [counts]
double pmax = 1; // maximum value of pressure range [bar, psi, kPa, etc.]
double pmin = 0; // minimum value of pressure range [bar, psi, kPa, etc.]
double percentage = 0; // holds percentage of full scale data
char printBuffer[200], cBuff[20], percBuff[20], pBuff[20], tBuff[20];
void setup() {
  Serial.begin(9600);
  while (!Serial) {
    delay(10);
  sprintf(printBuffer, "\nStatus Register, 24-bit Sensor data, Digital Pressure Counts,\
  Percentage of full scale pressure, Pressure Output, Temperature \n");
  Serial.println(printBuffer);
  SPI.begin();
  pinMode(10, OUTPUT); // pin 10 as SS
  digitalWrite(10, HIGH); // set SS High
void loop() {
  delay(1);
  while (1) {
    uint8_t data[7] = {0xF0, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00}; // holds output data
    uint8_t cmd[3] = \{0xAA, 0x00, 0x00\}; // command to be sent
    SPI.beginTransaction(SPISettings(200000, MSBFIRST, SPI_MODE0)); //SPI at 200kHz
    digitalWrite(10, LOW); // set SS Low
    SPI.transfer(cmd, 3); // send Read Command
    digitalWrite(10, HIGH); // set SS High
    delay(10); // wait for conversion
    digitalWrite(10, LOW);
    SPI.transfer(data, 7);
    digitalWrite(10, HIGH);
    SPI.endTransaction();
    press_counts = (double)((int32_t)data[3]+(int32_t)data[2]*(int32_t)256+
    (int32 t)data[1]*(int32 t)65536); // calculate digital pressure counts
    temp\_counts = (double)((int32\_t)data[6]+(int32\_t)data[5]*(int32\_t)256+
    (int32_t)data[4]*(int32_t)65536); // calculate digital temperature counts
    temperature = (temp counts * 200 / 16777215) - 50; // calculate temperature in deg c
    percentage = (press counts / 16777215) * 100; // calculate pressure as percentage of full scale
    //calculation of pressure value according to equation 2 of datasheet
    pressure = ((press counts - outputmin) * (pmax - pmin)) / (outputmax - outputmin) + pmin;
    dtostrf(press counts, 4, 1, cBuff);
    dtostrf(percentage, 4, 3, percBuff);
    dtostrf(pressure, 4, 3, pBuff);
    dtostrf(temperature, 4, 3, tBuff);
     The below code prints the raw data as well as the processed data
     Data format: Status Register, 24-bit Sensor Data, Digital Counts, percentage of full scale pressure,
pressure output,
      temperature
    sprintf(printBuffer, "%x\t%2x %2x %2x\t%s\t%s\t%s\t%s\t, data[0], data[1], data[2], data[3],
            cBuff, percBuff, pBuff, tBuff);
    Serial.print(printBuffer);
    delay(10);
                                 ABP2 Series Basic Board Mount Pressure Sensors Datasheet | automation.honeywell.com/hss | 37
}
```

ABP2 SERIES

8.0 **ABP2 SERIES CALCULATIONS**

8.1 **DIGITAL OUTPUT VERSIONS**

8.1.1 **Pressure Output**

The ABP2 Series sensor pressure output may be expressed by the transfer function of the device as shown in Equation 1:

Equation 1: Pressure Sensor Transfer Function

Output =
$$\frac{\text{Output}_{\text{max}} - \text{Output}_{\text{min.}}}{P_{\text{max}} - P_{\text{min.}}} * (\text{Pressure} - P_{\text{min.}}) * \text{Output}_{\text{min.}}$$

Rearranging this equation to solve for Pressure provides Equation 2:

Equation 2: Pressure Output Function

Pressure =
$$\frac{(Output - Output_{min.}) * (P_{max.} - P_{min.})}{Output_{max} - Output_{min}} + P_{min.}$$

Where:

Output_{max.} = output at maximum pressure [counts]

Output_{min} = output at minimum pressure [counts]

P_{max.} = maximum value of pressure range [bar, psi, kPa, etc.]

P_{min.} = minimum value of pressure range [bar, psi, kPa, etc.]

Pressure = pressure reading [bar, psi, kPa, etc.]

Output = digital pressure reading [counts]

Example: Calculate the pressure for a -1 psi to 1 psi gage sensor with a 10 to 90 calibration, and a pressure output of 14260634 (decimal) counts:

Output_{max} = 15099494 counts (90 of 2^{24} counts or 0xE66666)

Output_{min.} = 1677722 counts (10 of 2^{24} counts or 0x19999A)

 $P_{max} = 1 psi$

 $P_{min.} = -1 psi$

Pressure = calculated pressure in psi

Output = 14260634 counts

Pressure =
$$\left(\frac{(14260634 - 1677722) \times (1 - (-1))}{15099494 - 1677722}\right) + (-1)$$

Pressure =
$$\left(\frac{25165824}{13421772}\right) + (-1)$$

Pressure = 0.875 psi

ABP2 SERIES

8.1.2 **Temperature Output**

The ABP2 Series sensor temperature output may be expressed by the transfer function of the device as shown in Equation 3:

Equation 3: Temperature Output Transfer Function

Temperature =
$$\frac{T_{out} * (T_{max.} - T_{min.})}{(2^{(24)} - 1)} + T_{min.}$$

Where:

Temperature = calculated temperature output in °C

T_{out} = digital temperature output in counts (decimal)

$$T_{min.} = -50$$
°C

Example: Calculate the temperature for a temperature output of 6291456 (decimal) counts.

Temperature =
$$\frac{T_{out} * (150 - (-50))}{(2^{(24)} - 1)} + T_{min.}$$

Temperature =
$$\frac{6291456 \times 200}{16777215} - 50$$

Temperature = 25°C

ABP2 SERIES

8.2 **ANALOG OUTPUT VERSIONS**

The ABP2 Series sensor temperature output may be expressed by the transfer function of the device as shown in Equation 1:

Equation 1: Pressure Output Transfer Function

Output =
$$\frac{Output_{max.} - Output_{min.}}{P_{max.} - P_{min.}} * (Pressure - P_{min.}) + Output_{min.}$$

Pressure =
$$\frac{(Output - Output_{min.}) * (P_{max.} - P_{min.})}{Output_{max.} - Output_{min.}} + P_{min.}$$

Where:

 $Output_{max.}$ = output at maximum pressure [Vdc]

 $Output_{min.}$ = output at minimum pressure [Vdc]

P_{max.} = maximum value of pressure range [bar, psi, kPa, etc.]

P_{min.} = minimum value of pressure range [bar, psi, kPa, etc.]

Pressure = pressure reading [bar, psi, kPa, etc.]

Output = digital pressure reading [Vdc]

Example: Calculate the pressure for a -1 psi to 1 psi gage sensor with a 10 % to 90 % calibration, and a pressure output of 2.805 Vdc at 3.3 Vdc supply voltage:

Output_{max.} =
$$2.97 \text{ Vdc} (90 \% \text{ of } V_{\text{supply}})$$

Output_{min.} =
$$0.33 \, \text{Vdc} (10 \, \% \, \text{of} \, V_{\text{supply}})$$

$$P_{max.} = 1 psi$$

$$P_{min} = -1 psi$$

Pressure = pressure in psi

Output = 2.805 Vdc

Pressure =
$$\left(\frac{(2.805 - 0.33) * (1 - (-1))}{2.97 - 0.33}\right) + (-1)$$

Pressure =
$$\left(\frac{4.95}{2.64}\right)$$
 -1

9.0 RECOMMENDED PNEUMATIC SENSOR CONNECTIONS

9.1 TUBING

Tubing is a common method of pneumatically connecting to the sensors and needs to be matched to the sensor's application to provide the required operating temperature range and working pressure. Depending on the working pressure range and operating temperature, the corresponding type of tubing can be selected (i.e., Superthane®, silicone, and vinyl). Silicone tubing, for instance, tends to be the easiest to which to connect; however, its working pressure is not as high as that of the other materials.

The lower the shore rating for the tubing, the easier it is to insert the tubing onto the sensor's pressure port; however, the lower shore rated tubing also has lower working pressures. For working pressures of 20 psi and below, silicone or vinyl tubing tends to be used. For pressures above 20 psi, Superthane® or low-density polyethylene tubing may be considered. Table 28 shows recommended tubing for use with the Honeywell Basic Board Mount Pressure Sensors.

Generally, when the working pressure is 15 psi or less, clamps are typically not required. However, because each application is different, the end use must be taken into account before determining whether clamps are necessary to ensure that the tubing remains in place and doesn't leak. Considerations include vibration, pressure spikes, and the type of tubing being used. A common clamping method is to use a plastic cable tie, available in a variety of sizes and found in most hardware stores. They are relatively easy to install and stay in place over time.

NOTICE

Instead of using a clamp, a small drop of epoxy may be applied to either pressure port prior to the tubing being placed onto the port or applied at the end of the tubing once the tubing is in place. This method holds the tubing in place and can further act as a sealing agent to help ensure a leak-tight connection between the pressure port and the tubing. A room temperature sealant is generally used for this purpose. Ensure that the epoxy doesn't block the hole in the port as it needs to remain open.

NOTICE

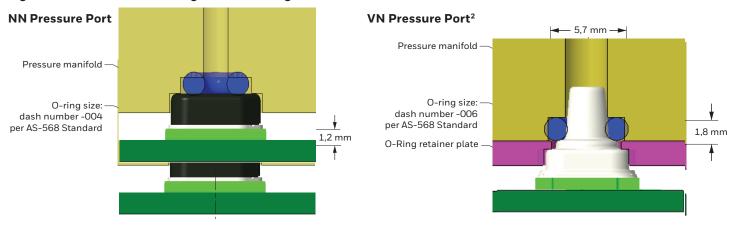
To apply a more rigid tubing-to-port connection, a low-power heat gun may be used to slightly heat the tubing. Once cooled, the tubing tends to grip the pressure port better.

TABLE 28. RECOMMENDED TUBING							
Pressure Port	Manufacturer	Туре	Part Number	ID	OD	Pressure at 25°C (psi)	
AN	Frelin-Wade	Fre-Thane® (polyurethane)	1A-156-11	0.093 in	0.156 in	210	
AN	Frelin-Wade	nylon	1A-200-01	0.093 in	0.125 in	270	
AN	NewAge Industries	PVC	1100225	0.094 in	0.156 in	42	
AN	NewAge Industries	silicone	2800315	0.094 in	0.156 in	20	
AN	McMaster	silicone	5041K512	2,0 mm	6,0 mm	60	
AN	McMaster	silicone	5041K601	2,0 mm	6,0 mm	115	
RN, RR	Frelin-Wade	Fre-Thane	95a-157	0.066 in	0.125 in	225	
RN, RR	NewAge Industries	Superthane® (ether)	2110535	0.066 in	0.125 in	135	
RN	NewAge Industries	silicone	2800161	0.063 in	0,188 in	20	
RN, RR	Du-Bro	silicone	196 1/16 ID	0.063 in	0.125 in	20	
RN, RR	US Plastics	Excelthane polyurethane	77901710	0.063 in	0.125 in	70	
RN, RR	McMaster	silicone	5041K603	1,0 mm	3.00 in	15	
DA	McMaster	silicone	5041K512	2,0 mm	6,0 mm	60	

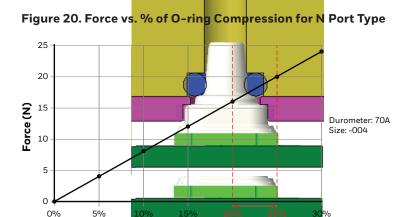
9.2 O-RING MANIFOLD DESIGNS

O-rings may also be used to connect pneumatically to the sensor. Most O-ring manufa of 20 % to 25 % to provide the proper O-ring compression over the temperature range are commonly used as they tend to take less of a set over temperature verses other Otemperatures and sealant media compatibility are the two most important parameters selecting an O-ring base polymer. See Figures 19 and 20, and Table 29 for more inform

Figure 19. Guidelines for O-ring Manifold Designs¹



AN Pressure Port SN Pressure Port² -5,05 mm **→** - 5,29 mm -> Pressure manifold Pressure manifold O-ring size: dash number -004 per AS-568 Standard 1,85 mm O-ring size: dash number -005 per AS-568 Standard O-Ring retainer plate 2,5 mm O-Ring retainer plate ing conditions ranging from -40°C to 110°C and up to 16 bar gage pressure. ¹The recommended



% of O-ring Compression

² For more demandi

(SN pressure port)

NOTICE

It is the buyer's sole responsibility to determine the suitability of the product in the application.

in be used with a gland height of 3,6 mm (VN pressure port) and 4,55 mm

TABLE 29. RECOMMENDED O-RINGS								
Pressure Port	O-ring size AS-568 uniform dash numbers	O-ring ID (mm)	O-ring C/S (mm)	Material	Supplier	Part Number	Shore Hardness	
NN	-004	1,78	1,78	Fluoroelastomer	McMaster	8333T114	Durometer 70A	
NN	-004	1,78	1,78	Silicone	McMaster	1283N14	Durometer 70A	
AN	-004	1,78	1,78	Fluoroelastomer	McMaster	8333T114	Durometer 70A	
AN	-004	1,78	1,78	Silicone	McMaster	1283N14	Durometer 70A	
SN	-005	2,57	1,78	Fluoroelastomer	McMaster	8333T115	Durometer 70A	
SN	-005	2,57	1,78	Silicone	McMaster	1283N15	Durometer 70A	
VN	-006	2,90	1,78	Fluoroelastomer	McMaster	8333T116	Durometer 70A	
VN	-006	2,90	1,78	Silicone	McMaster	1283N16	Durometer 70A	

△ WARNINGPERSONAL INJURY

DO NOT USE these products as safety or emergency stop devices or in any other application where failure of the product could result in personal injury.

Failure to comply with these instructions could result in death or serious injury.

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- The information presented in this product sheet is for reference only.
 Do not use this document as a product installation guide.
- Complete installation, operation, and maintenance information is provided in the instructions supplied with each product.

Failure to comply with these instructions could result in death or serious injury.

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